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1 Product profile

1.1 General description

NPN general-purpose transistors in a small SOT23 Surface-Mounted Device (SMD) plastic package.

Table 1. Product overview

Type number	Package	Package F				
	Nexperia	JEDEC	JEITA			
BC817	SOT23	TO-236AB	-	BC807		
BC817-16				BC807-16		
BC817-25				BC807-25		
BC817-40				BC807-40		

1.2 Features and benefits

- High current
- Three current gain selections
- AEC-Q101 qualified

1.3 Applications

· General-purpose switching and amplification



1.4 Quick reference data

Table 2. Quick reference data

 T_{amb} = 25 °C unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V_{CEO}	collector-emitter voltage	open base		-	-	45	V
I _C	collector current			-	-	500	mA
I _{CM}	peak collector current	single pulse; t _p ≤ 1 ms		-	-	1	Α
h _{FE}	BC817	V _{CE} = 1 V; I _C = 100 mA	[1]	100	-	600	
	BC817-16		[1]	100	-	250	
	BC817-25	-	[1]	160	-	400	
	BC817-40	-	[1]	250	-	600	

^[1] pulsed; $t_p \le 300 \ \mu s; \ \delta \le 0.02$

2 Pinning information

Table 3. Pinning

Pin	Symbol	Description	Simplified outline	Graphic symbol
SOT23				
1	В	base		
2	E	emitter	3	C
3	С	collector		В
				, E
				sym123

3 Ordering information

Table 4. Ordering information

Type number	Package				
	Name	Description	Version		
BC817	TO-236AB	Plastic surface-mounted package; 3 leads	SOT23		
BC817-16					
BC817-25					
BC817-40					

Marking

Table 5. Marking

Type number		Marking code
BC817	[1]	6D%
BC817-16	[1]	6A%
BC817-25	[1]	6B%
BC817-40	[1]	6C%

^{[1] % =} placeholder for manufacturing site code

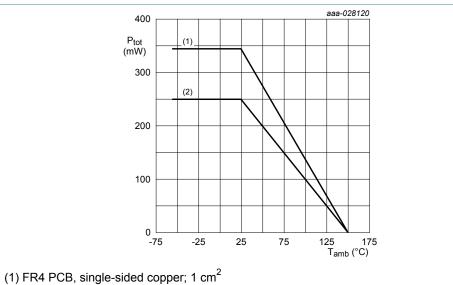
Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V_{CBO}	collector-base voltage	open emitter		-	50	V
V _{CEO}	collector-emitter voltage	open base		-	45	V
V_{EBO}	emitter-base voltage	open collector		-	5	V
I _C	collector current			-	500	mA
I _{CM}	peak collector current	single pulse; t _p ≤ 1 ms		-	1	Α
I _{BM}	peak base current	single pulse; t _p ≤ 1 ms		-	200	mA
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	[1] [2]	-	250	mW
			[3] [2]	-	345	mW
Tj	junction temperature			-	150	°C
T _{amb}	ambient temperature			-65	150	°C
T _{stg}	storage temperature			-65	150	°C

Device mounted on an FR4 Printed-Circuit-Board (PCB); single-sided copper; tin-plated and standard footprint.
 Valid for all available selection groups.
 Device mounted on an FR4 Printed-Circuit-Board (PCB); single-sided copper; tin-plated; mounting pad for collector 1 cm².



- (2) FR4 PCB, single-sided copper; standard footprint

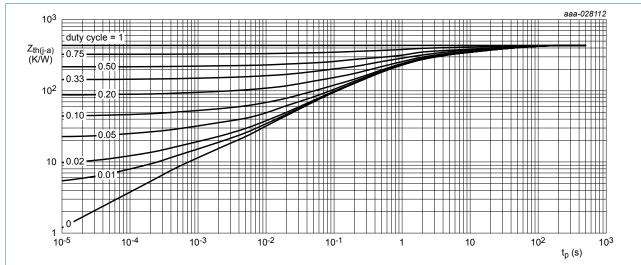
Figure 1. Power derating curves

Thermal characteristics

Table 7. Thermal characteristics

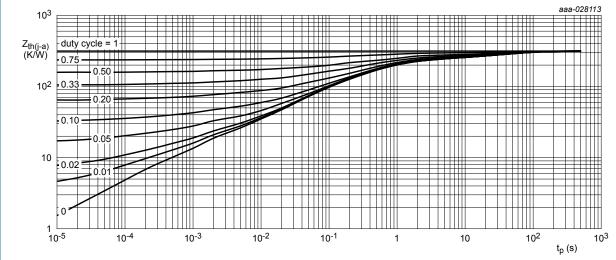
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R _{th(j-a)}	thermal resistance from junction	in free air	[1] [2]	-	-	500	K/W
	to ambient		[3] [2]	-	-	362	K/W

- [1] Device mounted on an FR4 Printed-Circuit-Board (PCB); single-sided copper; tin-plated and standard footprint.
- Valid for all available selection groups.
- [2] Valid for all available selection groups.
 [3] Device mounted on an FR4 Printed-Circuit-Board (PCB); single-sided copper; tin-plated; mounting pad for collector 1 cm².



FR4 PCB; single-sided copper; tin-plated and standard footprint

Figure 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



FR4 PCB; single-sided copper; tin-plated; mounting pad for collector 1 cm²

Figure 3. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

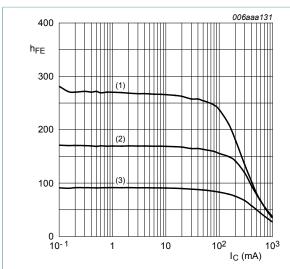
Characteristics

Table 8. Characteristics

 T_{amb} = 25 °C unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
$V_{(BR)CBO}$	collector-base breakdown voltage	I _C = 100 μA; I _E = 0 A		50	-	-	V
V _{(BR)CEO}	collector-emitter breakdown voltage	I _C = 10 mA; I _B = 0 A		45	-	-	V
$V_{(BR)EBO}$	emitter-base breakdown voltage	I _E = 100 μA; I _C = 0 A		5	-	-	V
I _{CBO}	collector-base	V _{CB} = 20 V; I _E = 0 A		-	-	100	nA
	cut-off current	$V_{CB} = 20 \text{ V}; I_E = 0 \text{ A}; T_j = 150 ^{\circ}\text{C}$		-	-	5	μΑ
I _{EBO}	emitter-base cut-off current	V _{EB} = 5 V; I _C = 0 A		-	-	100	nA
h _{FE}	DC current gain						
	BC817	V _{CE} = 1 V; I _C = 100 mA	[1]	100	-	600	
	BC817-16	V _{CE} = 1 V; I _C = 100 mA	[1]	100	-	250	
	BC817-25	V _{CE} = 1 V; I _C = 100 mA	[1]	160	-	400	
	BC817-40	V _{CE} = 1 V; I _C = 100 mA	[1]	250	-	600	
h _{FE}	DC current gain	V _{CE} = 1 V; I _C = 500 mA	[1]	40	-	-	
V _{CEsat}	collector-emitter saturation voltage	I _C = 500 mA; I _B = 50 mA	[1]	-	-	700	mV
V _{BE}	base-emitter voltage	V _{CE} = 1 V; I _C = 500 mA	[1] [2]	-	-	1.2	V
f _T	transition frequency	V _{CE} = 5 V; I _C = 10 mA; f = 100 MHz		100	-	-	MHz
C _c	collector capacitance	V _{CB} = 10 V; I _E = i _e = 0 A; f = 1 MHz		-	3	-	pF

 $[\]begin{array}{ll} [1] & \text{pulsed; } t_p \leq 300 \ \mu s; \ \delta \leq 0.02 \\ [2] & V_{BE} \ decreases \ by \ approxymately \ 2 \ mV/K \ with \ increasing \ temperature. \end{array}$



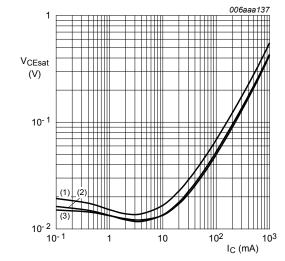
$$V_{CE} = -1 V$$

(1)
$$T_{amb} = 150 \, ^{\circ}C$$

(2)
$$T_{amb} = 25 \, ^{\circ}C$$

$$(3) T_{amb} = -55 °C$$

Figure 4. BC817-16: DC current gain as a function of collector current; typical values



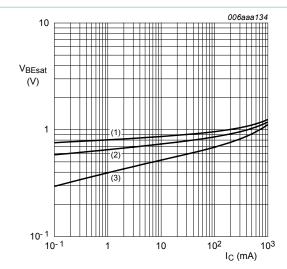
$$I_{\rm C}/I_{\rm B} = 10$$

(1)
$$T_{amb} = 150 \, ^{\circ}C$$

(2)
$$T_{amb} = 25 \, ^{\circ}C$$

(3)
$$T_{amb} = -55$$
 °C

Figure 6. BC817-16: Collector-emitter saturation voltage as a function of collector current; typical values



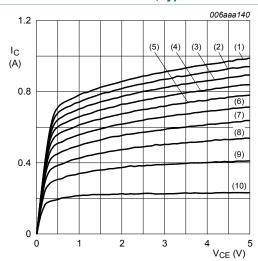
$$I_{\rm C}/I_{\rm B} = 10$$

(1)
$$T_{amb} = -55$$
 °C

(2)
$$T_{amb} = 25 \, ^{\circ}C$$

(3)
$$T_{amb} = 150 \, ^{\circ}C$$

Figure 5. BC817-16: Base-emitter saturation voltage as a function of collector current; typical values



(1)
$$I_B = -16.0 \text{ mA}$$

(2)
$$I_B = -14.4 \text{ mA}$$

(3)
$$I_B = -12.8 \text{ mA}$$

(4)
$$I_B = -11.2 \text{ mA}$$

$$(5) I_B = -9.6 \text{ mA}$$

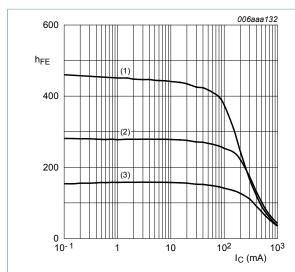
(6)
$$I_B = -8.0 \text{ mA}$$

$$(7) I_B = -6.4 \text{ mA}$$

(8)
$$I_B = -4.8 \text{ mA}$$

(9)
$$I_B = -3.2 \text{ mA}$$

Figure 7. BC817-16: Collector current as a function of collector-emitter voltage; typical values

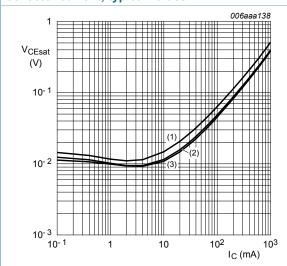


$$V_{CE} = 1 V$$

(1)
$$T_{amb}$$
 = 150 °C

$$(3) T_{amb} = -55 °C$$

Figure 8. BC817-25: DC current gain as a function of collector current; typical values



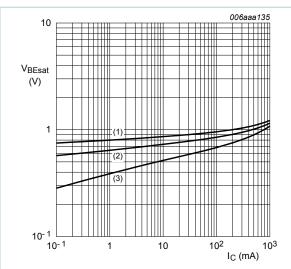
$$I_{\rm C}/I_{\rm B} = 10$$

(1)
$$T_{amb} = 150 \, ^{\circ}C$$

(2)
$$T_{amb} = 25 \, ^{\circ}C$$

(3)
$$T_{amb} = -55$$
 °C

Figure 10. BC817-25: Collector-emitter saturation voltage as a function of collector current; typical values



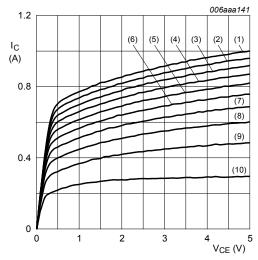
$$I_{\rm C}/I_{\rm B} = 10$$

(1)
$$T_{amb} = -55$$
 °C

(2)
$$T_{amb} = 25 \, ^{\circ}C$$

(3)
$$T_{amb} = 150 \, ^{\circ}C$$

Figure 9. BC817-25: Base-emitter saturation voltage as a function of collector current; typical values



(1)
$$I_B = 13.0 \text{ mA}$$

(2)
$$I_B = 11.7 \text{ mA}$$

(3)
$$I_B = 10.4 \text{ mA}$$

(4)
$$I_B = 9.1 \text{ mA}$$

$$(5) I_B = 7.8 \text{ mA}$$

(6)
$$I_B = 6.5 \text{ mA}$$

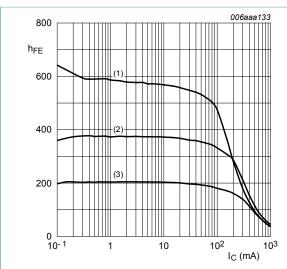
$$(7) I_B = 5.2 \text{ mA}$$

(8)
$$I_B = 3.9 \text{ mA}$$

(9)
$$I_B = 2.6 \text{ mA}$$

$$(10) I_B = 1.3 mA$$

Figure 11. BC817-25: Collector current as a function of collector-emitter voltage; typical values



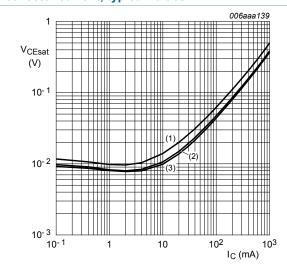
$$V_{CE} = 1 V$$

(1)
$$T_{amb}$$
 = 150 °C

(2)
$$T_{amb} = 25 \, ^{\circ}C$$

(3)
$$T_{amb} = -55$$
 °C

Figure 12. BC817-40: DC current gain as a function of collector current; typical values



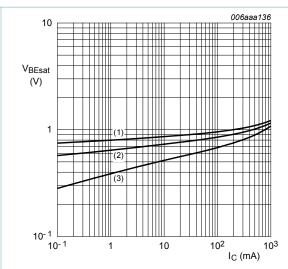
$$I_{\rm C}/I_{\rm B} = 10$$

(1)
$$T_{amb} = 150 \, ^{\circ}C$$

(2)
$$T_{amb} = 25 \, ^{\circ}C$$

(3)
$$T_{amb} = -55$$
 °C

Figure 14. BC817-40: Collector-emitter saturation voltage as a function of collector current; typical values



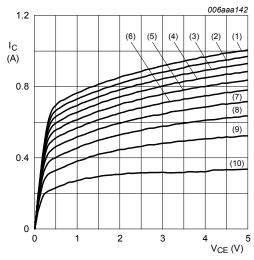
$$I_{\rm C}/I_{\rm B} = 10$$

(1)
$$T_{amb} = -55$$
 °C

(2)
$$T_{amb} = 25 \, ^{\circ}C$$

(3)
$$T_{amb} = 150 \, ^{\circ}C$$

Figure 13. BC817-40: Base-emitter saturation voltage as a function of collector current; typical values



(1)
$$I_B = 12.0 \text{ mA}$$

(2)
$$I_B = 10.8 \text{ mA}$$

(3)
$$I_B = 9.6 \text{ mA}$$

(4)
$$I_B = 8.4 \text{ mA}$$

(5)
$$I_B = 7.2 \text{ mA}$$

(6)
$$I_B = 6.0 \text{ mA}$$

$$(7) I_B = 4.8 \text{ mA}$$

(8)
$$I_B = 3.6 \text{ mA}$$

(9) $I_B = 2.4 \text{ mA}$

$$(10) I_B = 1.2 mA$$

Figure 15. BC817-40: Collector current as a function of collector-emitter voltage; typical values

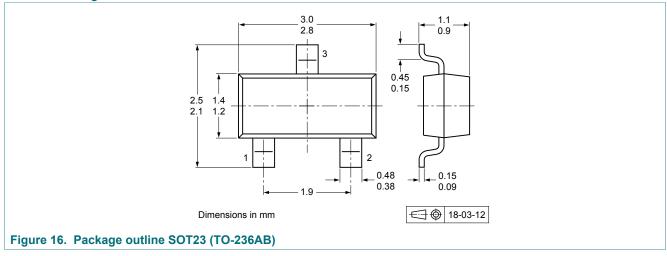
8 Test information

8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

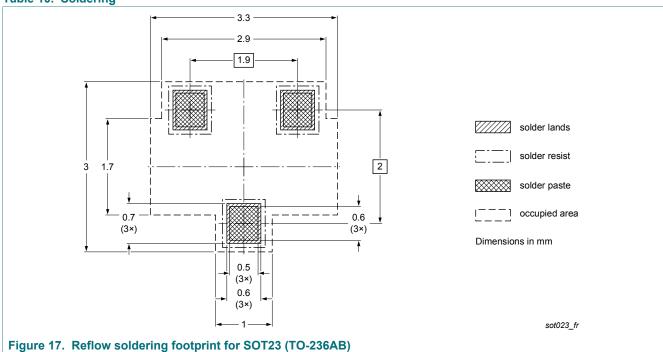
9 Package outline

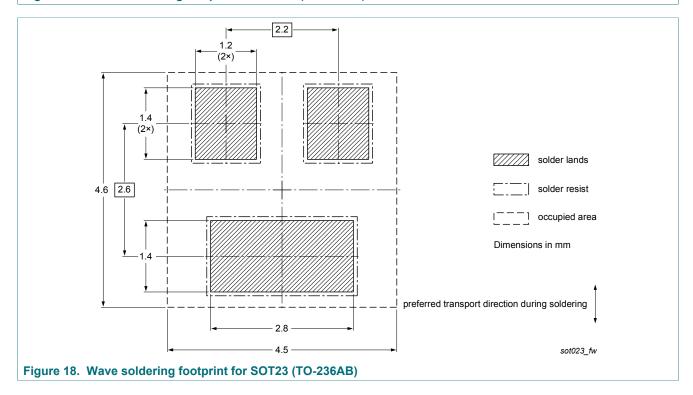
Table 9. Package outline



10 Soldering







11 Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes		
BC817 v.7	20180618	Product data sheet	-	BC817_BC817W_BC337 v.6		
Modifications:	Nexperia. Legal text Removed Added Fig Fig 2. and Graphs in Added se	exts have been adapted to the new company name where appropriate. ed basic types: BC327 and BC807W (separate data sheet). Fig 1. Power derating curves in section "Limiting values" and the thermal graphs as and Fig 3. in section "Thermal characteristics". in section "Characteristics" are sorted in new order. sections 8 "Test information" and 9 "Soldering". ed Section "Packing information"				
BC817_BC817W_BC337 v.6	20091117	Product data sheet	-	BC817_BC817W_BC337 v.5		
BC817_BC817W_BC337 v.5	20050221	Product data sheet	CPCN200302007F CPCN200405006F	BC817 v.4; BC817W_SER v.4; BC337 v.3		
BC817 v.4	20040116	Product Specification	-	BC817 v.3		
BC817W_SER v.4	20040225	Product Specification	-	BC817W_SER v.3		
BC337 v.3	19990415	Product Specification	-	BC337_338_CNV v.2		

12 Legal information

12.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
- The term 'short data sheet' is explained in section "Definitions". [2] [3]
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Nexperia BC817 series

45 V, 500 mA NPN general-purpose transistors

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BC817 series

45 V, 500 mA NPN general-purpose transistors

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